

# 2SJ351, 2SJ352

# Silicon P Channel MOS FET

REJ03G0860-0200

(Previous: ADE-208-1193)

Rev.2.00 Sep 07, 2005

### **Description**

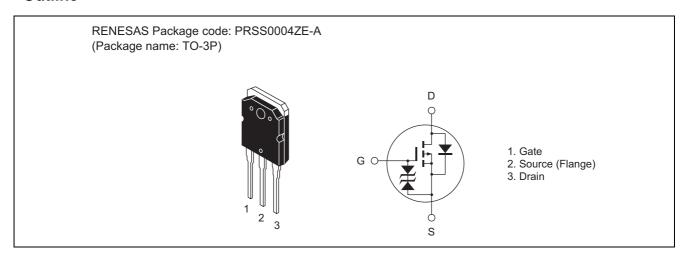
Low frequency power amplifier

Complementary pair with 2SK2220, 2SK2221

### **Features**

- High power gain
- Excellent frequency response
- High speed switching
- Wide area of safe operation
- Enhancement-mode
- Good complementary characteristics
- Equipped with gate protection diodes

### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item		Symbol	Value	Unit	
Drain to source voltage	2SJ351	V <sub>DSX</sub>	-180	V	
	2SJ352		-200		
Gate to source voltage		V <sub>GSS</sub>	±20	V	
Drain current		I <sub>D</sub>	-8	Α	
Body to drain diode reverse drain current		I <sub>DR</sub>	-8	Α	
Channel dissipation		Pch Note 1	100	W	
Channel temperature		Tch	150	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note: 1. Value at Tc = 25°C

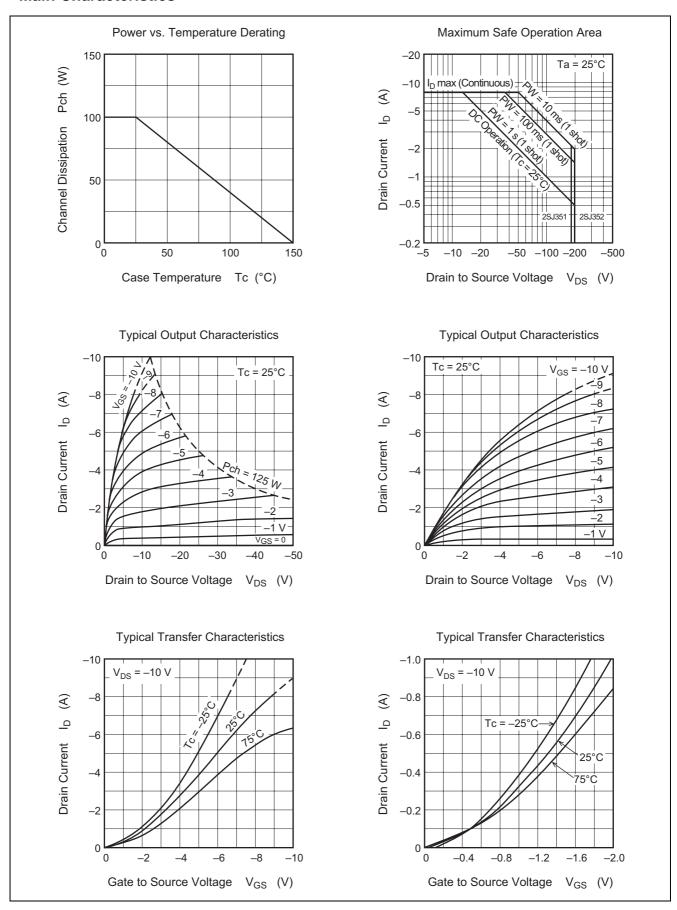
### **Electrical Characteristics**

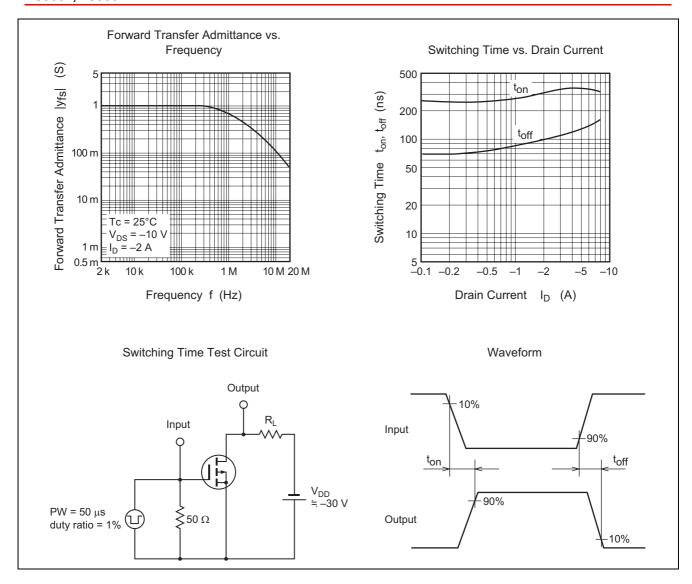
 $(Ta = 25^{\circ}C)$ 

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown	2SJ351	V <sub>(BR) DSX</sub>	-180	—	_	V	$I_D = -10 \text{ mA}, V_{GS} = 10 \text{ V}$
voltage	2SJ352		-200	_	_	V	
Gate to source breakdown voltage		V <sub>(BR) GSS</sub>	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source cutoff voltage		V <sub>GS (off)</sub>	-0.15		-1.45	>	$I_D = -100 \text{ mA}, V_{DS} = -10 \text{ V}$
Drain to source saturation voltage		V <sub>DS (sat)</sub>			-12	>	$I_D = -8 \text{ A}, V_{GS} = 0^{\text{Note 2}}$
Forward transfer admittance		y <sub>fs</sub>	0.7	1.0	1.4	Ø	$I_D = -3 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 2}}$
Input capacitance		Ciss		800		pF	$V_{GS} = 5 \text{ V}, V_{DS} = -10 \text{ V},$
Output capacitance		Coss		1000		pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	18	_	pF	
Turn-on time		t <sub>on</sub>		320		ns	$V_{DD} = -30 \text{ V } I_{D} = -4 \text{ A}$
Turn-off time		t <sub>off</sub>	_	120	_	ns	

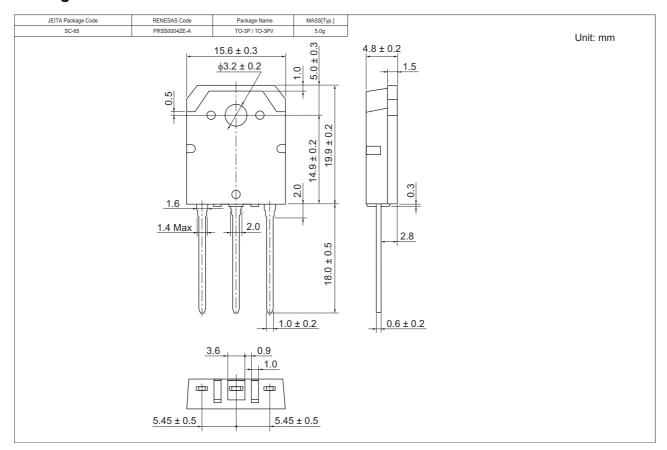
Note: 2. Pulse test

### **Main Characteristics**





### **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container		
2SJ351-E	360 pcs	Box (Tube)		
2SJ352-E	360 pcs	Box (Tube)		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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